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(12) **United States Design Patent**
Buck et al.

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(54) **ELECTRICAL GROUND SHIELD**

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(57) **CLAIM**
The ornamental design for an electrical ground shield, as shown and described.

(**) Term: **14 Years**

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DESCRIPTION

Related U.S. Application Data

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(51) **LOC (10) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/154**

(58) **Field of Classification Search**
USPC D13/147, 154, 184, 199; 439/74, 108,
439/180, 246, 252, 278, 374, 378, 379, 381,
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439/953; 174/16.3; 257/697, 727; 361/769
See application file for complete search history.

FIG. 1 is a top, left, front perspective view of a first embodiment of an electrical ground shield showing my new design. FIG. 2 is a bottom, right, rear perspective view thereof; FIG. 3 is a front elevation view thereof; FIG. 4 is a rear elevation view thereof; FIG. 5 is a top plan view thereof; FIG. 6 is a bottom plan view thereof; FIG. 7 is a left side elevation view thereof; and FIG. 8 is a right side elevation view thereof; FIG. 9 is a top, left, front perspective view of a second embodiment of an electrical ground shield showing my new design; FIG. 10 is a bottom, right, rear perspective view thereof; FIG. 11 is a front elevation view thereof; FIG. 12 is a rear elevation view thereof; FIG. 13 is a top plan view thereof; FIG. 14 is a bottom plan view thereof; FIG. 15 is a left side elevation view thereof; and, FIG. 16 is a right side elevation view thereof. The broken line portion of the figure drawings is included to show unclaimed subject matter only for the purpose of illustrating environment and forms no part of the claimed design. In a preferred embodiment, the nature of this product is an electrical component that can take the form of an electrical ground shield for a vertical backplane electrical connector.

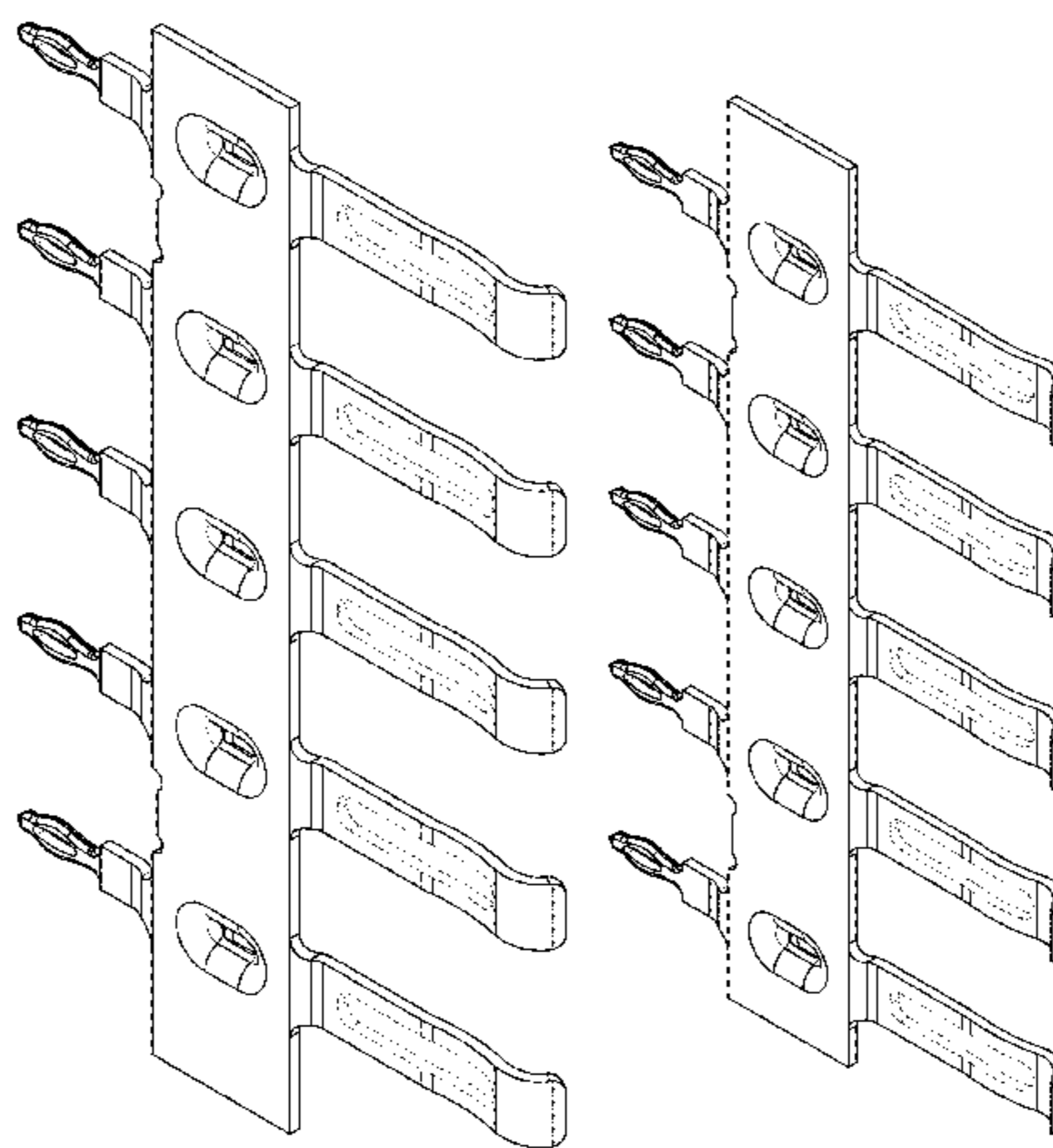
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1 Claim, 8 Drawing Sheets



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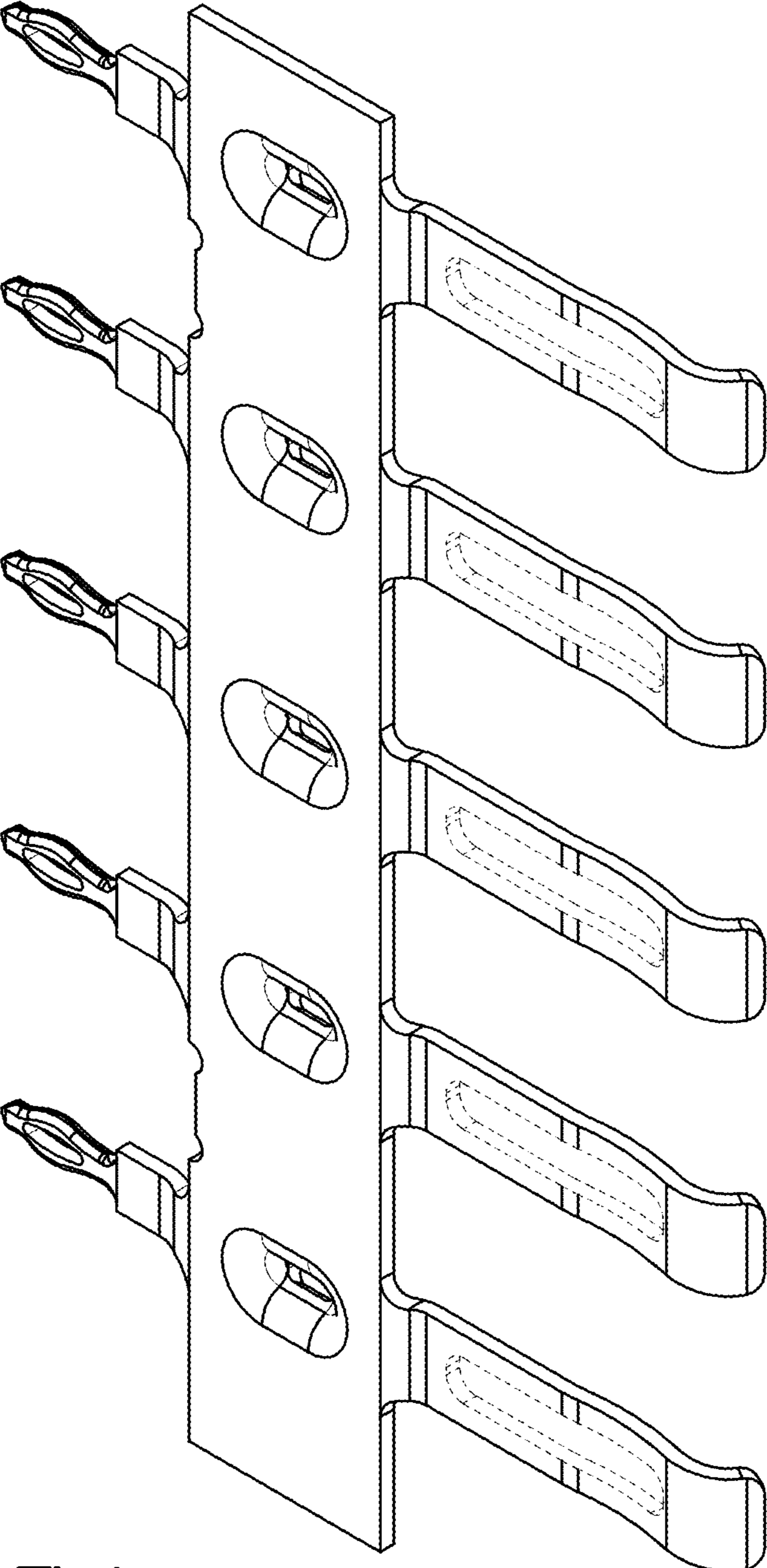


Fig.1

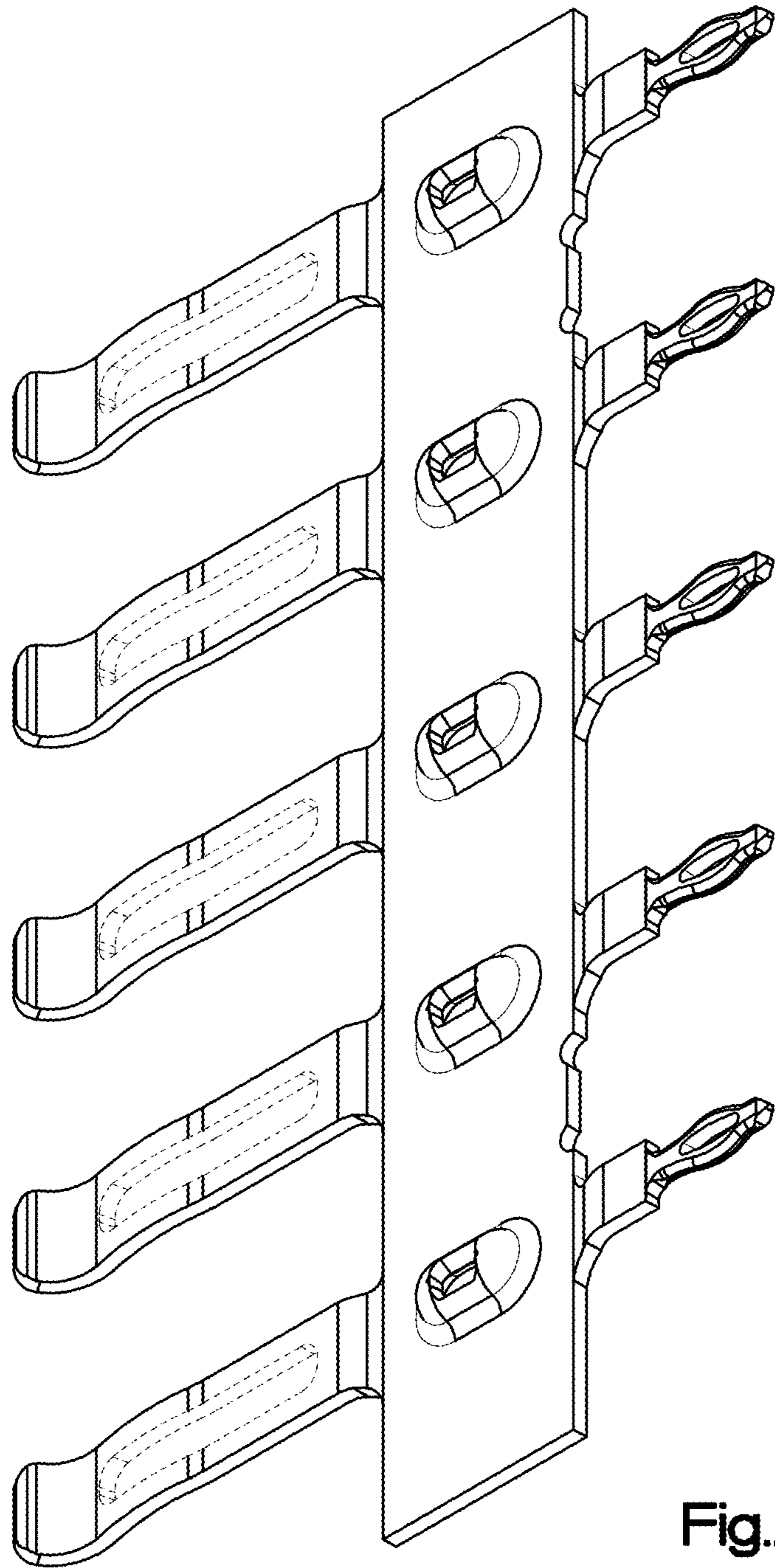


Fig.2



Fig.6



Fig.5



Fig.4



Fig.3

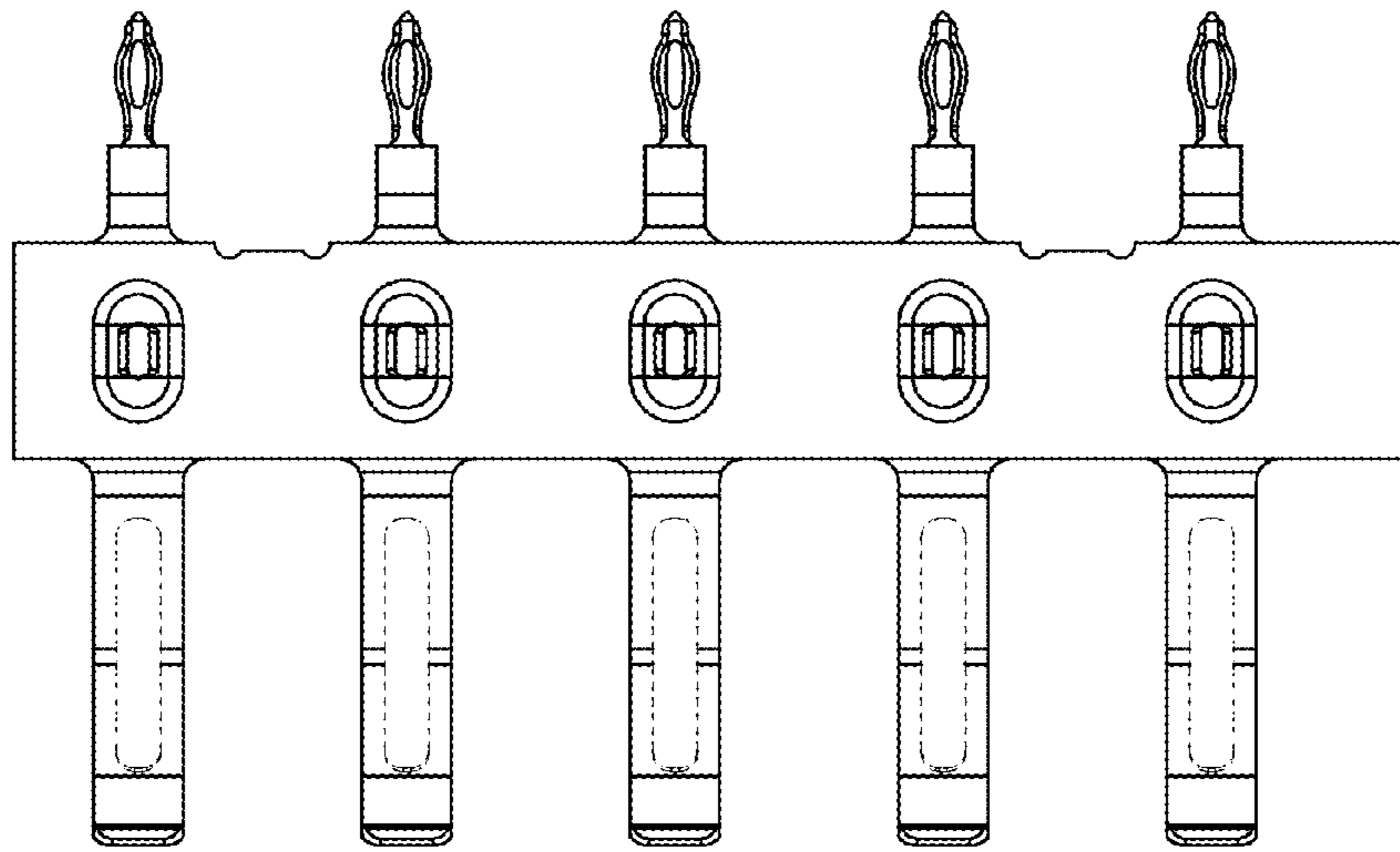


Fig.8

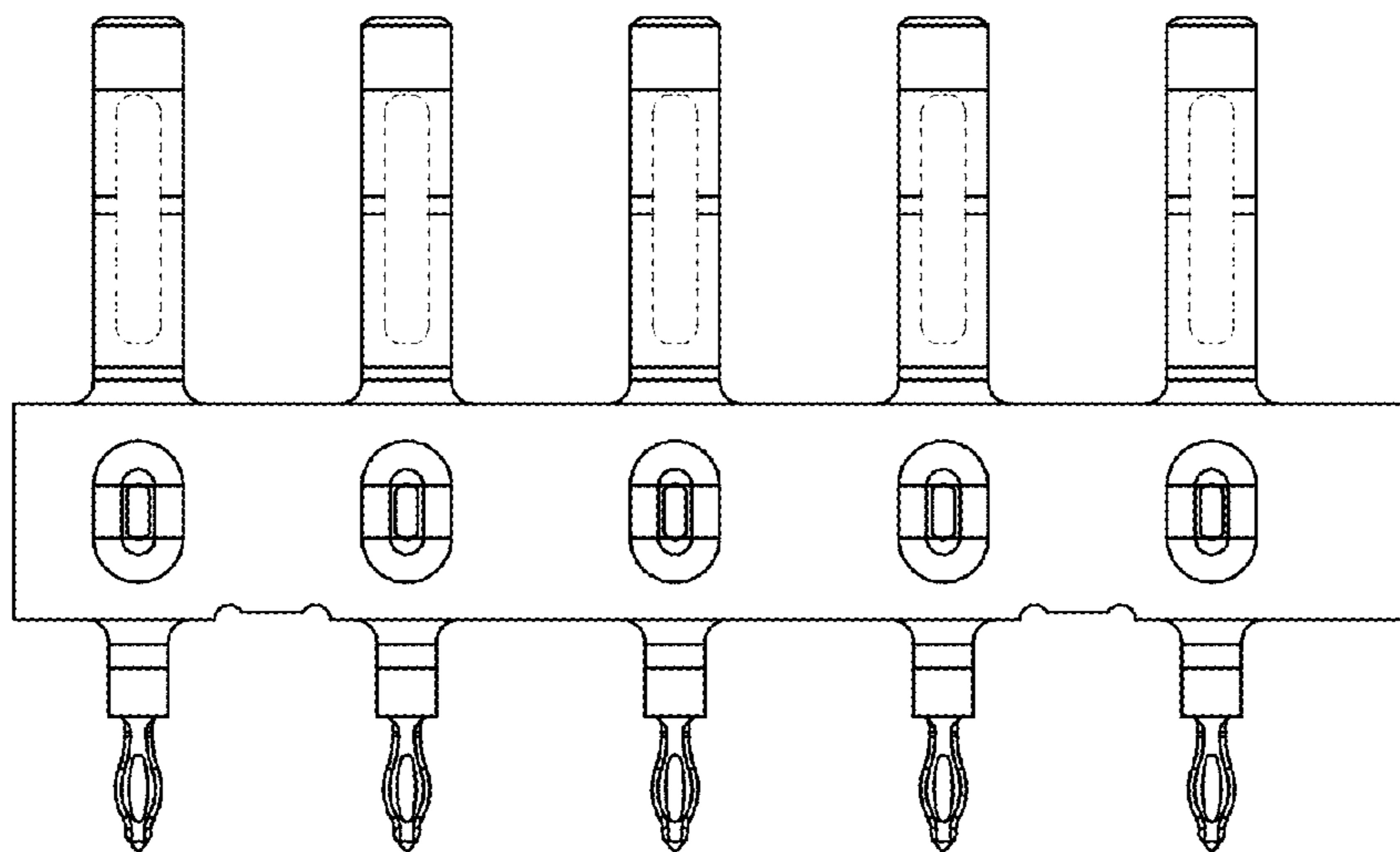


Fig.7

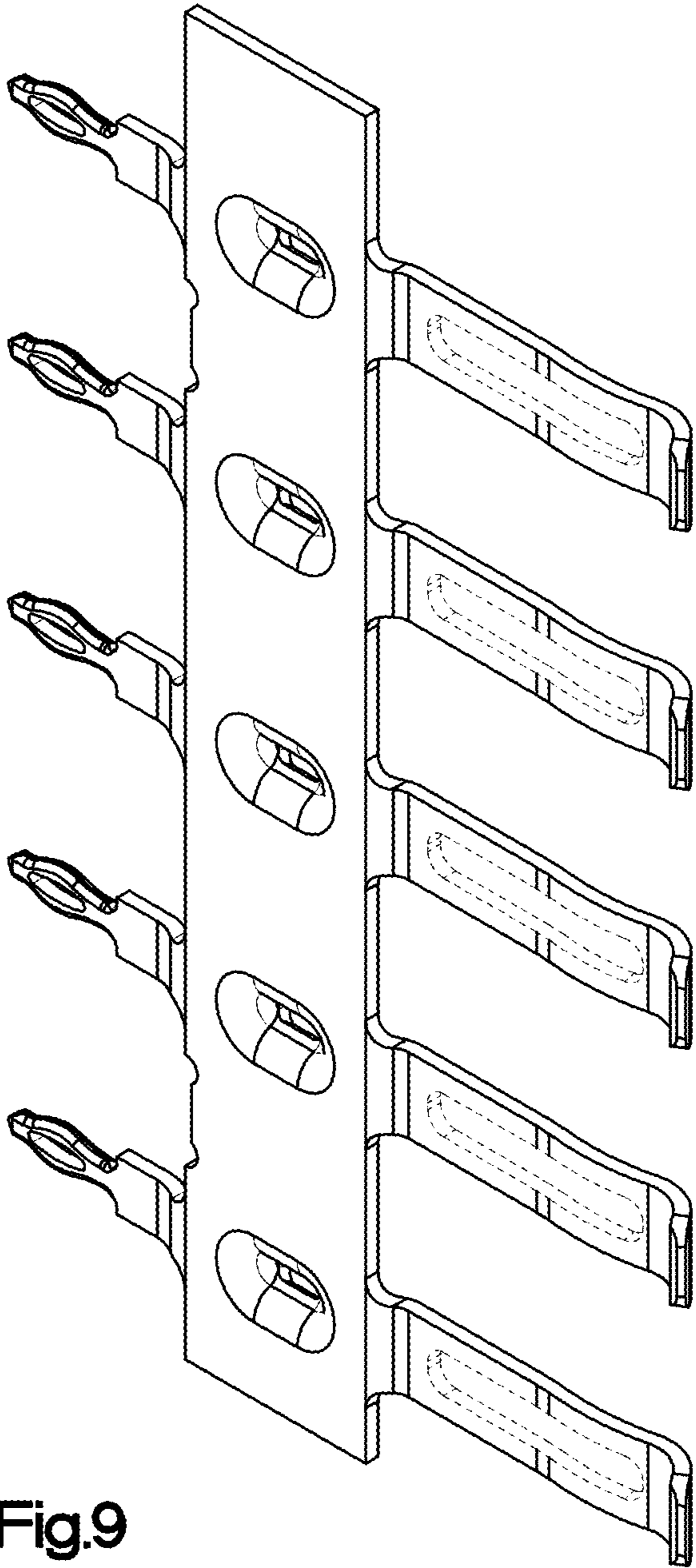


Fig.9

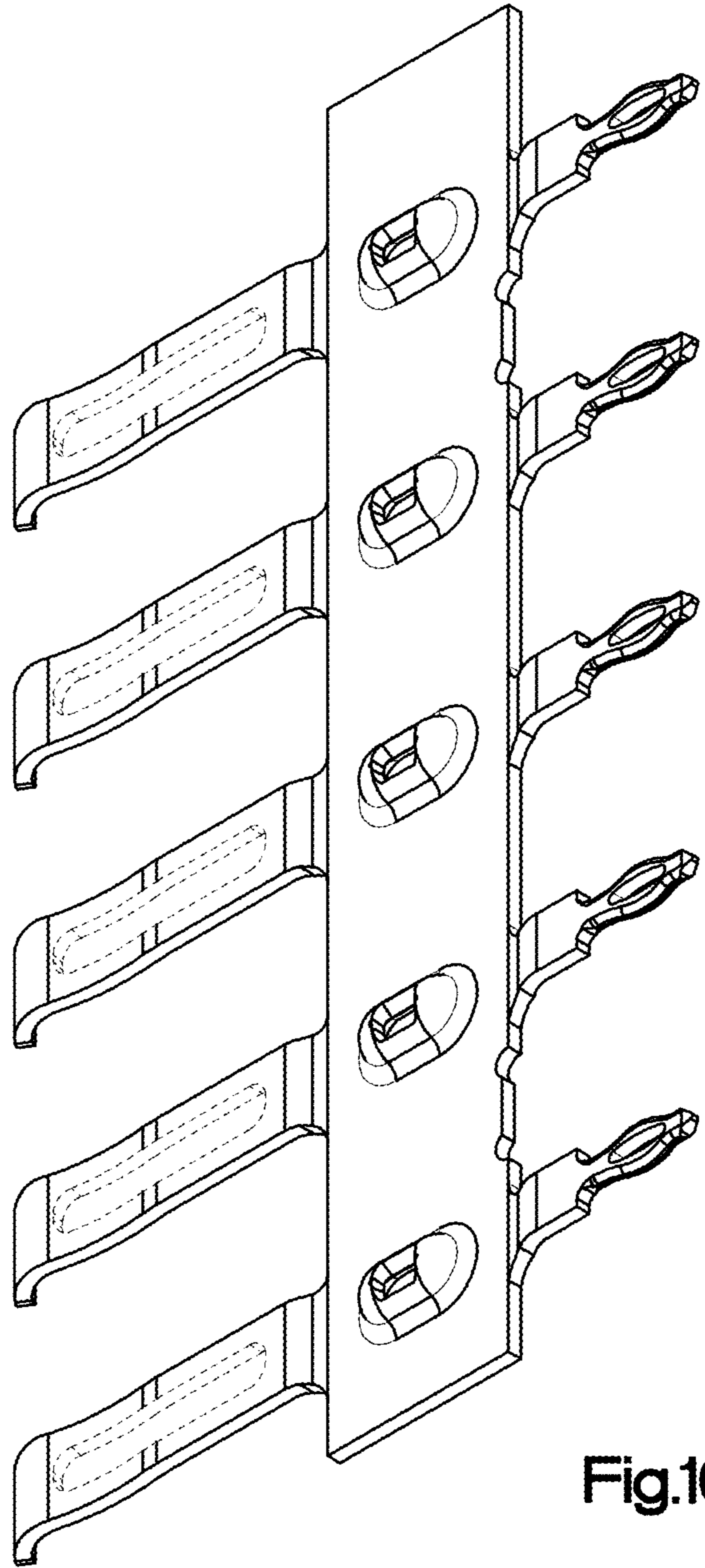


Fig.10



Fig.11



Fig.12



Fig.13

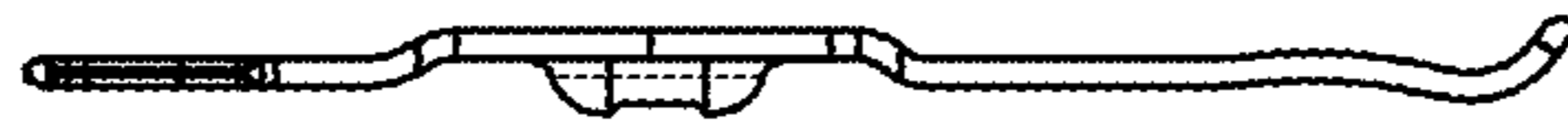


Fig.14

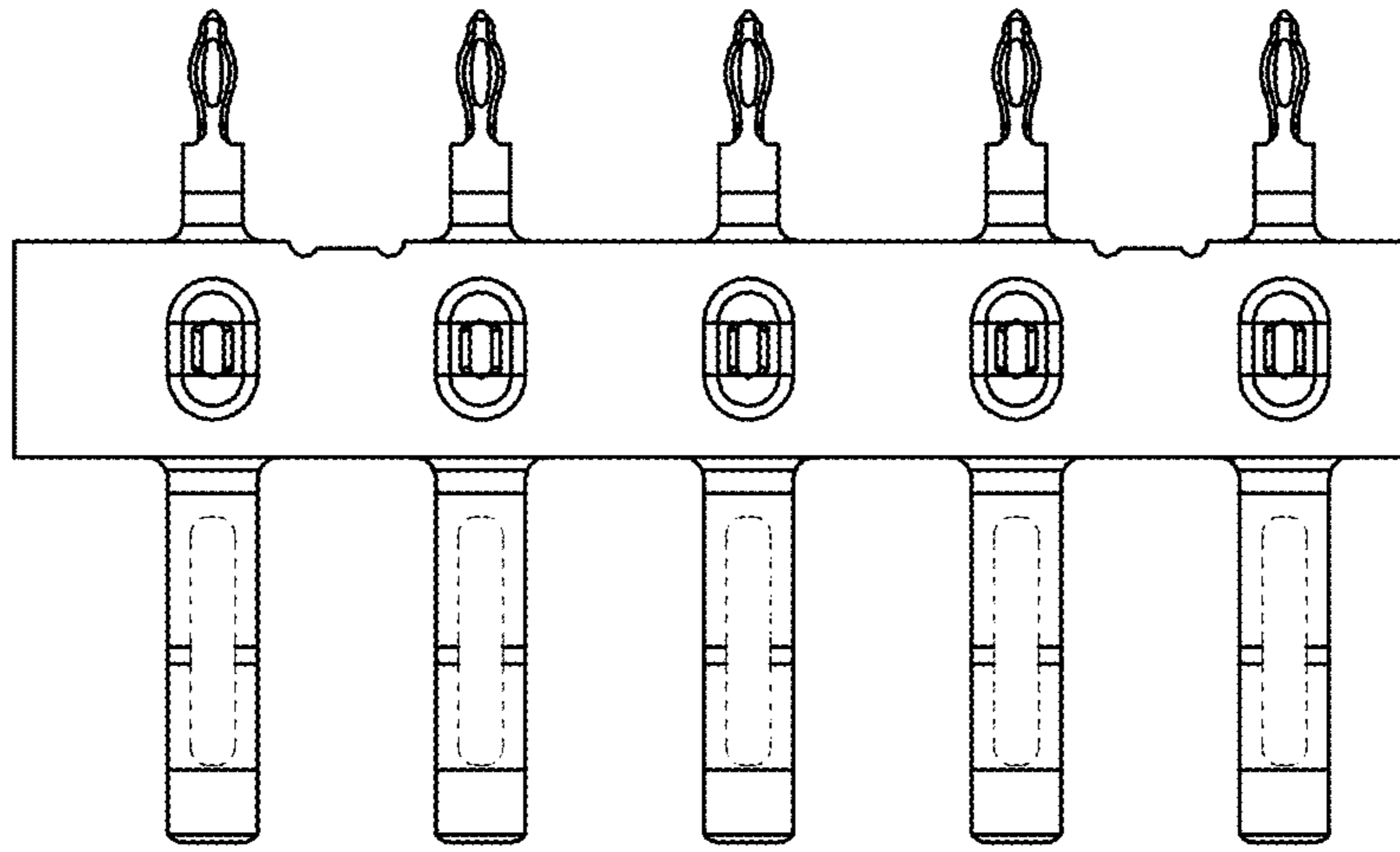


Fig.16

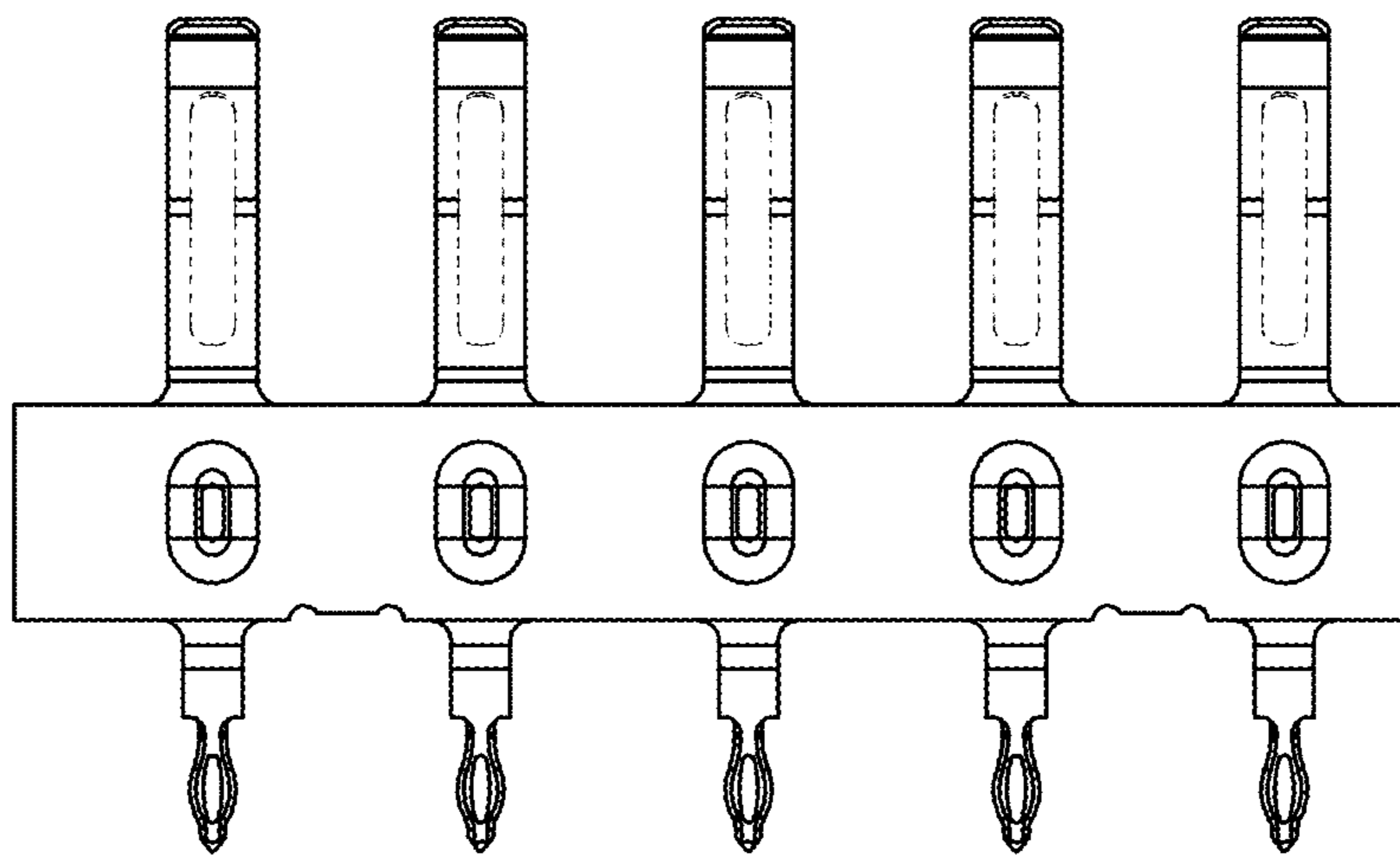


Fig.15